



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 6855**
Akihisa HONGO et al. : Docket No. 2001-1846
Serial No. 10/017,384 : Group Art Unit 1742
Filed December 18, 2001 : Examiner Donald R. Valentine

SUBSTRATE PLATING METHOD AND
APPARATUS

RECEIVED

MAR 04 2004

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of September 3, 2003, the period for response to which having been extended by three months to March 3, 2004, kindly amend the above-referenced U.S. patent application as follows:

03/03/2004 BABRAHA1 00000094 10017384

02 FC:1201

86.00 OP